



**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Application No.: 10/647,297                      Group Art Unit: 1794  
Filing Date: August 26, 2003                      Examiner: Hai Vo  
Applicants: Hyun HUH et al.                      Conf. No.: 2580  
Title: POLISHING PAD CONTAINING EMBEDDED  
LIQUID MICROELEMENTS AND METHOD OF  
MANUFACTURING THE SAME

Attorney Docket: 47881-000003/US

Customer Service Window  
Randolph Building  
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Alexandria, VA 22314  
**Mail Stop AF**

April 7, 2009

**AMENDMENT UNDER 37 C.F.R. § 1.114**

Sir:

In response to the Office Action mailed January 9, 2009, the following remarks are respectfully submitted in connection with the above-identified application.

**Amendments to the Claims** begins on page 2 of this Amendment.

**Remarks** begin on page 5 of this Amendment.

	Claims remaining after Amendment		Highest number previously paid for		Present extra
<b>Total</b>	14	-	31	=	0
<b>Independent</b>	1	-	3	=	0